# Onsemi

MARKING DIAGRAM

# Low Voltage Quad 2-Input **AND Gate with 5 V Tolerant** Inputs

# 74LCX08

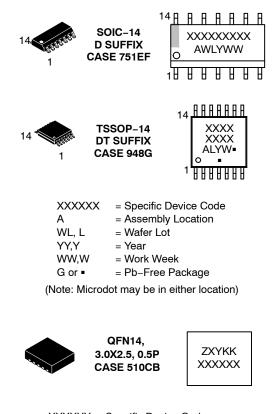
### **General Description**

The LCX08 contains four 2-input AND gates. The inputs tolerate voltages up to 5.5 V allowing the interface of 5 V systems to 3 V systems.

The 74LCX08 is fabricated with an advanced CMOS technology to achieve high Speed operation while Maintaining CMOS Low Power Dissipation.

### Features

- 5 V Tolerant Inputs
- 1.65 V 5.5 V V<sub>CC</sub> Specifications Provided
- 5.5 ns  $t_{PD}$  max. (V<sub>CC</sub> = 3.3 V), 10  $\mu$ A I<sub>CC</sub> max.
- Power Down High Impedance Inputs and Outputs
- $\pm 24$  mA Output Drive (V<sub>CC</sub> = 3.0 V)
- Implements Proprietary Noise/EMI Reduction Circuitry
- Latch-up Performance Exceeds JEDEC 78 Conditions
- ESD Performance:
  - ♦ Human body model > 2000 V
- Leadless DQFN Package
- These Devices are Pb-Free, Halide Free and are RoHS Compliant



XXXXXX = Specific Device Code Ζ

= Assembly Plant Code

XY = Date Code

KK = Lot Run Traceability Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 7 of this data sheet.

1

# **CONNECTION DIAGRAMS**

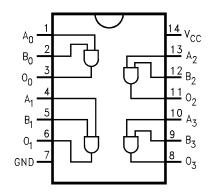


Figure 1. Pin Assignments for SOIC, SOP and TSSOP

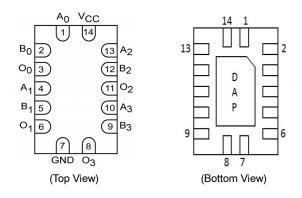


Figure 2. Pad Assignments for DQFN

# LOGIC SYMBOL

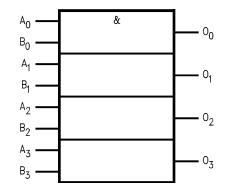


Figure 3. IEEE/IEC

### PIN DESCRIPTION

Pin Names	Description
A <sub>n</sub> , B <sub>n</sub>	Inputs
On	Outputs
DAP	No Connect

NOTE: DAP (Die Attach Pad)

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter		Value	Unit
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		-0.5 to +6.5	V
V <sub>O</sub>		Mode (High or Low State) Tri-State Mode -Down Mode (V <sub>CC</sub> = 0 V)	$\begin{array}{c} -0.5 \text{ to } V_{CC} + 0.5 \\ -0.5 \text{ to } +6.5 \\ -0.5 \text{ to } +6.5 \end{array}$	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>I</sub> < GND	-50	mA
Ι <sub>ΟΚ</sub>	DC Output Diode Current	V <sub>O</sub> < GND	-50	mA
Ι <sub>Ο</sub>	DC Output Source/Sink Current	±50	mA	
$I_{\rm CC}$ or $I_{\rm GND}$	DC Supply Current per Supply Pin or Ground Pin		±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 secs		260	°C
TJ	Junction Temperature Under Bias		+150	°C
$\theta_{JA}$	Thermal Resistance (Note 1)	SOIC-14 QFN14 TSSOP-14	116 130 150	°C/W
PD	Power Dissipation in Still Air at 125°C	SOIC-14 QFN14 TSSOP-14	1077 962 833	mW
MSL	Moisture Sensitivity		Level 1	_
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V <sub>ESD</sub>	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
I<sub>0</sub> absolute maximum rating must be observed.
Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A

(Machine Model) be discontinued.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol		Parameter	Min	Тур	Max	Unit
V <sub>CC</sub>	Supply Voltage	Operating Data Retention Only	1.65 1.5	3.3 3.3	5.5 5.5	V
VI	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active Mode (High or Low State) Tri-State Mode Power Down Mode (V <sub>CC</sub> = 0 V)	0 0 0		V <sub>CC</sub> 5.5 5.5	V
T <sub>A</sub>	Operating Free-Air Temperature		-40	-	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Rate	$\begin{array}{c} V_{CC} = 1.65 \text{ V to } 1.95 \text{ V} \\ V_{CC} = 2.3 \text{ V to } 2.7 \text{ V} \\ V_{IN} \text{ from } 0.8 \text{ V to } 2.0 \text{ V}, V_{CC} = 3.0 \text{ V} \\ V_{CC} = 4.5 \text{ V to } 5.5 \text{ V} \end{array}$	0 0 0	- - - -	20 20 10 5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

# DC ELECTRICAL CHARACTERISTICS

				T <sub>A</sub> = -40°0	C to +85°C	T <sub>A</sub> = -40°C	to +125°C	
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage		1.65 – 1.95	$0.65 \times V_{CC}$	-	$0.65 \times V_{CC}$	-	V
			2.3 – 2.7	1.7	-	1.7	-	
			3.0 - 3.6	2.0	-	2.0	-	
			4.5 – 5.5	$0.70 \times V_{CC}$	_	$0.70 \times V_{CC}$	-	
V <sub>IL</sub>	LOW Level Input Voltage		1.65 – 1.95	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
			2.3 – 2.7	-	0.7	-	0.7	
			3.0 - 3.6	-	0.8	-	0.8	
			4.5 – 5.5	-	$0.30 \times V_{CC}$	-	$0.30 \times V_{CC}$	
V <sub>OH</sub>	High-Level Output Voltage		1.65 - 5.5 1.65 2.3 2.7 3.0 3.0 4.5	V <sub>CC</sub> - 0.1 1.29 1.8 2.2 2.4 2.2 3.7	- - - - -	V <sub>CC</sub> - 0.1 1.29 1.8 2.2 2.4 2.2 3.7		V
V <sub>OL</sub>	Low-Level Output Voltage		1.65 - 5.5 1.65 2.3 2.7 3.0 3.0 4.5	- - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.6	- - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.6	V
I	Input Leakage Current	V <sub>I</sub> = 0 to 5.5 V	1.65 – 5.5	_	±5.0	-	±5.0	μA
I <sub>OFF</sub>	Power Off Leakage Current	$V_{I} = 5.5 V \text{ or}$ $V_{O} = 5.5 V$	0	-	10	-	10	μA
Icc	Quiescent Supply Current	$V_{I}$ = 5.5 V or GND	1.65 – 5.5	-	10	-	10	μA
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	$V_{IH} = V_{CC} - 0.6 V$	2.3 – 3.6	_	500	-	500	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### AC ELECTRICAL CHARACTERISTICS

				$T_A = -40^{\circ}$	C to +85°C	T <sub>A</sub> = -40°C	to +125°C						
Symbol	Parameter	Test Condition	V <sub>CC</sub> (V)	Min	Max	Min	Max	Unit					
t <sub>PLH</sub> , t <sub>PHL</sub> Propagation Delay,	See Figures 4	1.65 –1.95	-	9.8	-	9.8	ns						
	Input to Output	and 5	2.3 – 2.7	1.5	6.6	1.5	6.6						
			2.7	1.5	6.2	1.5	6.2						
		F							3.0 – 3.6	1.5	5.5	1.5	5.5
									4.5 – 5.5	-	4.0	-	4.0
t <sub>OSHL</sub> , t <sub>OSLH</sub>	Output to Output Skew		1.65 – 1.95	-	-	-	-	ns					
			2.3 – 2.7	-	-	-	-						
								2.7	_	-	-	-	
			3.0 – 3.6	-	1.0	-	1.0						
			4.5 – 5.5	_	-	-	-						

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

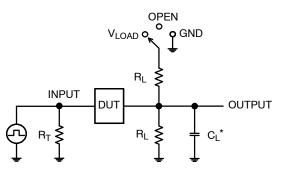
#### **DYNAMIC SWITCHING CHARACTERISTICS**

				T <sub>A</sub> = 25°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Test Conditions	Typical	Unit
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	3.3	$C_L$ = 50 pF, $V_{IH}$ = 3.3 V, $V_{IL}$ = 0 V	0.8	V
		2.5	$C_L$ = 30 pF, $V_{IH}$ = 2.5 V, $V_{IL}$ = 0 V	0.6	
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	3.3	$C_L$ = 50 pF, $V_{IH}$ = 3.3 V, $V_{IL}$ = 0 V	-0.8	V
		2.5	$C_L$ = 30 pF, $V_{IH}$ = 2.5 V, $V_{IL}$ = 0 V	-0.6	

#### CAPACITANCE

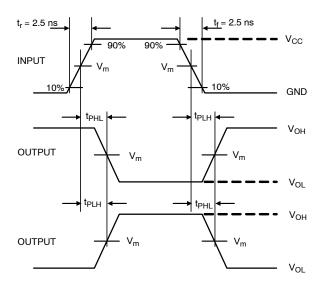
Symbol	Parameter	Test Conditions	Typical	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = Open, $V_I$ = 0 V or $V_{CC}$	7.0	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$	8.0	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC,}f$ = 10 MHz	25.0	pF

# AC LOADING AND WAVEFORMS (GENERIC FOR LCX FAMILY)

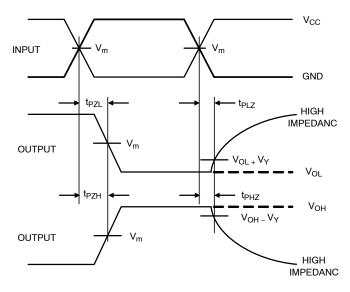


Test	Switch Position
t <sub>PLH</sub> / t <sub>PHL</sub>	Open
t <sub>PLZ</sub> / t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> / t <sub>PZH</sub>	GND

 $C_L$  includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega$ ) f = 1 Mhz, t<sub>W</sub> = 500 ns



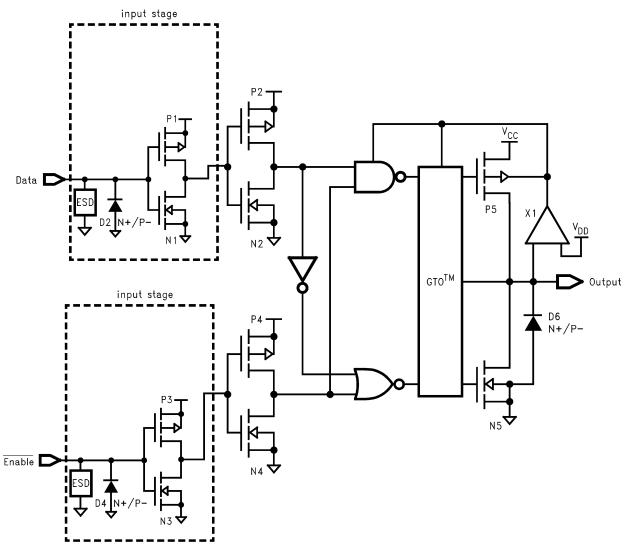




V <sub>CC</sub> , V	$R_L, \Omega$	C <sub>L</sub> , pF	V <sub>LOAD</sub>	V <sub>m</sub> , V	V <sub>Y</sub> , V
1.65 to 1.95	500	30	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.15
2.3 to 2.7	500	30	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.15
2.7	500	50	6 V	1.5	0.3
3.0 to 3.6	500	50	6 V	1.5	0.3
4.5 to 5.5	500	50	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.3

Figure 5. Switching Waveforms

## SCHEMATIC DIAGRAM (Generic for LCX Family)





# **ORDERING NFORMATION**

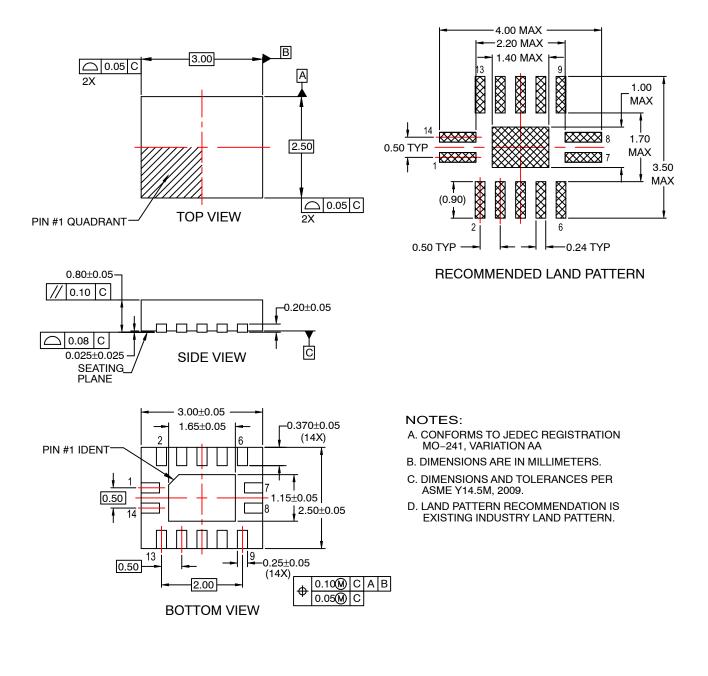
Product Number	Marking	Package	Shipping <sup>†</sup>
74LCX08MTCX	LCX 08	TSSOP-14	2500 Units / Tape and Reel
74LCX08BQX	LCX08	QFN-14	3000 Units / Tape and Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.



QFN14 3.0x2.5, 0.5P CASE 510CB ISSUE O

DATE 31 AUG 2016



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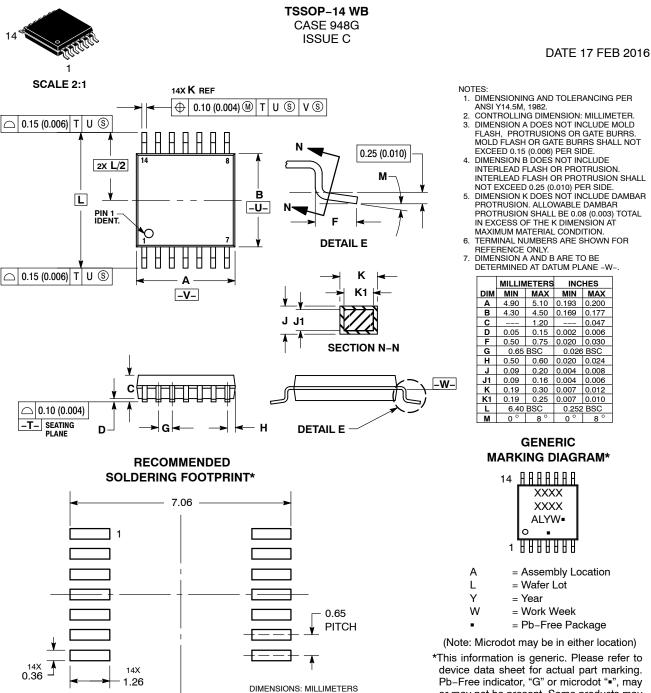
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SOIC14 CASE 751EF **ISSUE O** DATE 30 SEP 2016 8.75 Α 8.50 0.65 7.62 14 8 14 8 В ₽ ╞ 4.00 6.00 5.60 3.80 Ħ = ╞ = Ħ 1.70 7 **PIN #1** 7 1.27 1 0.51 IDENT. 1.270.35 (0.33) - $\oplus$  0.25 (M) С В Α LAND PATTERN RECOMMENDATION TOP VIEW 1.75 MAX 0.25 0.19 0.10 С 1.50 0.25 1.25 0.10 SIDE VIEW FRONT VIEW NOTES: A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C **B. ALL DIMENSIONS ARE IN MILLIMETERS** 0.50 0.25 × 45° C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS R0.10 GAGE D. LAND PATTERN STANDARD: PLANE SOIC127P600X145-14M E. CONFORMS TO ASME Y14.5M, 2009 R0.10 0.36 8° 0° 0.90 0.50 SEATING PLANE (1.04)**DETAIL A** SCALE 16:1

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- INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL

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